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● Member of the Texas Instruments <i>Widebus™</i> Family	DGG, DGV, OR DL PACKAGE (TOP VIEW)
<ul> <li>EPIC<sup>™</sup> (Enhanced-Performance Implanted CMOS) Submicron Process</li> </ul>	NC 1 56 GND NC 2 55 NC
<ul> <li>ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)</li> </ul>	Y1 [] 3 54 ]] A1 GND [] 4 53 ]] GND Y2 [] 5 52 ]] A2
<ul> <li>Latch-Up Performance Exceeds 250 mA Per JESD 17</li> </ul>	Y3 [ 6 51 ] A3 V <sub>CC</sub> [ 7 50 ] V <sub>CC</sub>
<ul> <li>Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors</li> </ul>	Y4 [ 8 49 ] A4 Y5 [ 9 48 ] A5 Y6 [ 10 47 ] A6
<ul> <li>Package Options Include Plastic Shrink Small-Outline (DL), Thin Shrink</li> </ul>	GND   11 46   GND Y7   12 45   A7
Small-Outline (DGG), and Thin Very Small-Outline (DGV) Packages	Y8 [ 13 44 ] A8 Y9 [ 14 43 ] A9 Y10 [ 15 42 ] A10
description	Y11 🛛 16 🛛 41 🗍 A11
This 18-bit universal bus driver is designed for 1.65-V to 3.6-V V <sub>CC</sub> operation.	Y12 [] 17 40 [] A12 GND [] 18 39 [] GND Y13 [] 19 38 [] A13
Data flow from A to Y is controlled by the output-enable ( $\overline{OE}$ ) input. The device operates in	Y14 [ 20 37 ] A14 Y15 [ 21 36 ] A15
the transparent mode when the latch-enable (LE) input is high. The A data is latched if the clock	V <sub>CC</sub> [ 22 35 ] V <sub>CC</sub> Y16 [ 23 34 ] A16
(CLK) input is held at a high or low logic level. If LE is low, the A data is stored in the latch/flip-flop on the low-to-high transition of CLK. When OE is	Y17 [ 24 33 ] A17 GND [ 25 32 ] GND Y18 [ 26 31 ] A18

NC - No internal connection

30 CLK

29 GND

OE 27

LE 28

52

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high, the outputs are in the high-impedance state.

To ensure the high-impedance state during power up or power down,  $\overline{\text{OE}}$  should be tied to V<sub>CC</sub>

through a pullup resistor; the minimum value of the resistor is determined by the current-sinking

Active bus-hold circuitry is provided to hold unused or floating data inputs at a valid logic level. The SN74ALVCH16835 is characterized for

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

capability of the driver.

operation from -40°C to 85°C.



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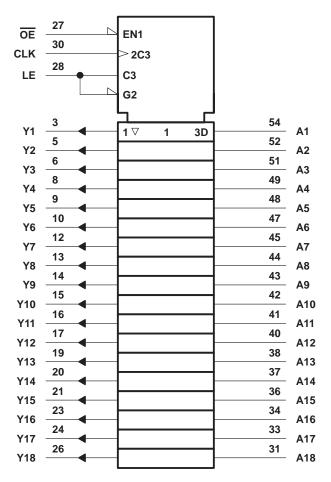
#### FUNCTION TABLE

	INP	OUTPUT							
OE	LE	CLK	Α	Y					
Н	Х	Х	Х	Z					
L	Н	Х	L	L					
L	Н	Х	Н	н					
L	L	$\uparrow$	L	L					
L	L	$\uparrow$	Н	н					
L	L	Н	Х	Y0 <sup>†</sup> Y0 <sup>‡</sup>					
L	L	L	Х	Y0‡					

<sup>†</sup> Output level before the indicated steady-state input conditions were established, provided that CLK is high before LE goes low

<sup>‡</sup>Output level before the indicated steady-state input conditions were established

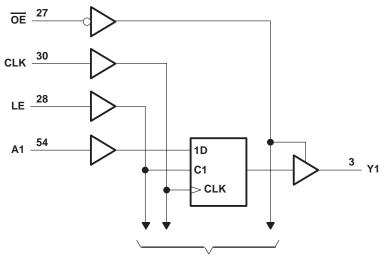
### logic symbol§



§ This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.



logic diagram (positive logic)



To 17 Other Channels

### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

Supply voltage range, V <sub>CC</sub>		–0.5 V to 4.6 V
Input voltage range, VI (see Note 1)		–0.5 V to 4.6 V
Output voltage range, V <sub>O</sub> (see Notes 1 and 2)		-0.5 V to V <sub>CC</sub> + 0.5 V
Input clamp current, IIK (VI < 0)		
Output clamp current, I <sub>OK</sub> (V <sub>O</sub> < 0)		
Continuous output current, IO		±50 mA
Continuous current through each V <sub>CC</sub> or GND		±100 mA
Package thermal impedance, $\theta_{JA}$ (see Note 3):	: DGG package	81°C/W
	DGV package	
	DL package	
Storage temperature range, T <sub>stg</sub>		–65°C to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.

- 2. This value is limited to 4.6 V maximum.
- 3. The package thermal impedance is calculated in accordance with JESD 51.



## SN74ALVCH16835 **18-BIT UNIVERSAL BUS DRIVER** WITH 3-STATE OUTPUTS SCES053E – SEPTEMBER 1995 – REVISED FEBRUARY 1999

## recommended operating conditions (see Note 4)

			MIN	MAX	UNIT	
VCC	Supply voltage		1.65	3.6	V	
		V <sub>CC</sub> = 1.65 V to 1.95 V	$0.65 \times V_{CC}$			
$V_{\text{IH}}$	High-level input voltage	$V_{CC}$ = 2.3 V to 2.7 V	1.7		V	
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	2			
		V <sub>CC</sub> = 1.65 V to 1.95 V		$0.35 \times V_{CC}$		
VIL	Low-level input voltage	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		0.7	V	
		$V_{CC} = 2.7 V \text{ to } 3.6 V$		0.8	1	
VI	Input voltage		0	VCC	V	
Vo	Output voltage		0	VCC	V	
		V <sub>CC</sub> = 1.65 V		-4		
1	High-level output current	$V_{CC} = 2.3 V$		-12	mA	
ЮН		$V_{CC} = 2.7 V$		-12		
		V <sub>CC</sub> = 3 V		-24		
		V <sub>CC</sub> = 1.65 V		4		
1		V <sub>CC</sub> = 2.3 V	12		1	
IOL	Low-level output current	$V_{CC} = 2.7 V$		12	mA	
	V <sub>CC</sub> = 3 V			24		
$\Delta t/\Delta v$	Input transition rise or fall rate			10	ns/V	
TA	Operating free-air temperature		-40	85	°C	

NOTE 4: All unused control inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



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PA	RAMETER	TEST CONDITIONS	Vcc	MIN	түр†	MAX	UNIT	
		I <sub>OH</sub> = -100 μA	1.65 V to 3.6 V	V <sub>CC</sub> -0.	2			
		$I_{OH} = -4 \text{ mA}$	1.65 V	1.2				
VOH	$I_{OH} = -6 \text{ mA}$	2.3 V	2					
		2.3 V	1.7			V		
	$I_{OH} = -12 \text{ mA}$	2.7 V	2.2					
			3 V	2.4				
		$I_{OH} = -24 \text{ mA}$	3 V	2				
		I <sub>OL</sub> = 100 μA	1.65 V to 3.6 V			0.2		
		I <sub>OL</sub> = 4 mA	1.65 V			0.45		
Max		I <sub>OL</sub> = 6 mA	2.3 V			0.4	V	
VOL		1	2.3 V			0.7	V	
		I <sub>OL</sub> = 12 mA	2.7 V			0.4		
		I <sub>OL</sub> = 24 mA	3 V			0.55		
lj		V <sub>I</sub> = V <sub>CC</sub> or GND	3.6 V			±5	μΑ	
		V <sub>I</sub> = 0.58 V	1.65 V	25				
		V <sub>I</sub> = 1.07 V	1.65 V	-25				
		V <sub>I</sub> = 0.7 V	2.3 V	45				
II(hold)		V <sub>I</sub> = 1.7 V	2.3 V	-45			μΑ	
		V <sub>I</sub> = 0.8 V	3 V	75				
		V <sub>I</sub> = 2 V	3 V	-75				
		V <sub>I</sub> = 0 to 3.6 V <sup>‡</sup>	3.6 V			±500		
I <sub>OZ</sub>		$V_{O} = V_{CC} \text{ or } GND$	3.6 V			±10	μΑ	
ICC		$V_{I} = V_{CC} \text{ or GND}, \qquad I_{O} = 0$	3.6 V			40	μΑ	
ΔICC		One input at $V_{CC}$ – 0.6 V, Other inputs at $V_{CC}$ or GND	3 V to 3.6 V			750	μΑ	
	Control inputs		0.01/		3.5		- 5	
Ci	Data inputs	VI = V <sub>CC</sub> or GND	3.3 V		6		pF	
Co	Outputs	V <sub>O</sub> = V <sub>CC</sub> or GND	3.3 V		7		pF	

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

<sup>†</sup> All typical values are at  $V_{CC}$  = 3.3 V,  $T_A$  = 25°C. <sup>‡</sup> This is the bus-hold maximum dynamic current. It is the minimum overdrive current required to switch the input from one state to another.

### timing requirements over recommended operating free-air temperature range (unless otherwise noted) (see Figures 1 through 3)

				V <sub>CC</sub> = 1.8 V		V <sub>CC</sub> = 2.5 V ± 0.2 V		V <sub>CC</sub> = 2.7 V		V <sub>CC</sub> = 3.3 V ± 0.3 V		UNIT
				MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
fclock	Clock freq	Clock frequency			§		150		150		150	MHz
t <sub>w</sub> Pulse duration	Pulse	LE high		§		3.3		3.3		3.3		
	duration CLK	CLK high or low		§		3.3		3.3		3.3		ns
	Setup time	Data before CLK↑		§		2.2		2.1		1.7		
t <sub>su</sub>		Data before LE↓	CLK high	§		1.9		1.6		1.5		ns
		unie	Data before LEV	CLK low	§		1.3		1.1		1	
4	Hold	Data after CLK↑	-	§		0.6		0.6		0.7		
th	time	Data after LE $\downarrow$	CLK high or low	§		1.4		1.7		1.4		ns

§ This information was not available at the time of publication.

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# switching characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Figures 1 through 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V <sub>CC</sub> =	1.8 V	V <sub>CC</sub> = ± 0.2	2.5 V 2 V	V <sub>CC</sub> =	2.7 V	V <sub>CC</sub> = ± 0.3	3.3 V 3 V	UNIT
		(001101)	MIN	TYP	MIN	MAX	MIN	MAX	MIN	MAX	
f <sub>max</sub>			†		150		150		150		MHz
	A			†	1	4.2		4.2	1	3.6	
<sup>t</sup> pd	LE	Y		†	1.3	5		4.9	1.3	4.2	ns
	CLK			†	1.4	5.5		5.2	1.4	4.5	
ten	OE	Y		†	1.4	5.5		5.6	1.1	4.6	ns
<sup>t</sup> dis	OE	Y		†	1	4.5		4.3	1.3	3.9	ns

<sup>†</sup> This information was not available at the time of publication.

## switching characteristics from 0°C to 65°C, $C_L$ = 50 pF

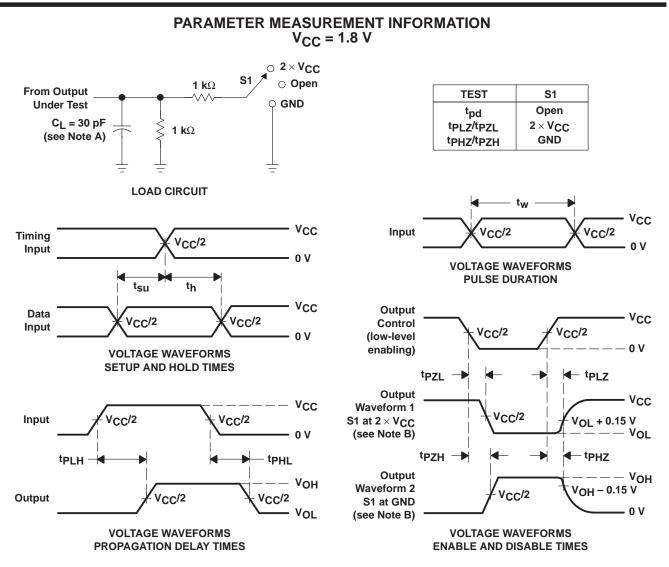
PARAMETER	FROM (INPUT)	TO (OUTPUT)	V <sub>CC</sub> = 3.3 V ± 0.15 V		UNIT
		(661161)	MIN	MAX	
<sup>t</sup> pd	CLK	Y	1.7	4.5	ns

## operating characteristics, $T_A = 25^{\circ}C$

PARAMETER		PARAMETER TEST CONDITIONS			V <sub>CC</sub> = 2.5 V	V <sub>CC</sub> = 3.3 V	UNIT
	PARAMETER		TEST CONDITIONS	TYP	TYP	TYP	UNIT
	C <sub>pd</sub> Power dissipation capacitance	Outputs enabled	$C_{1} = 50 \text{ pc}$ f = 10 MHz	†	26	31	рF
Cpd		Outputs disabled	$C_{L} = 50 \text{ pF}, \text{ f} = 10 \text{ MHz}$	†	12	14	рг

<sup>†</sup> This information was not available at the time of publication.



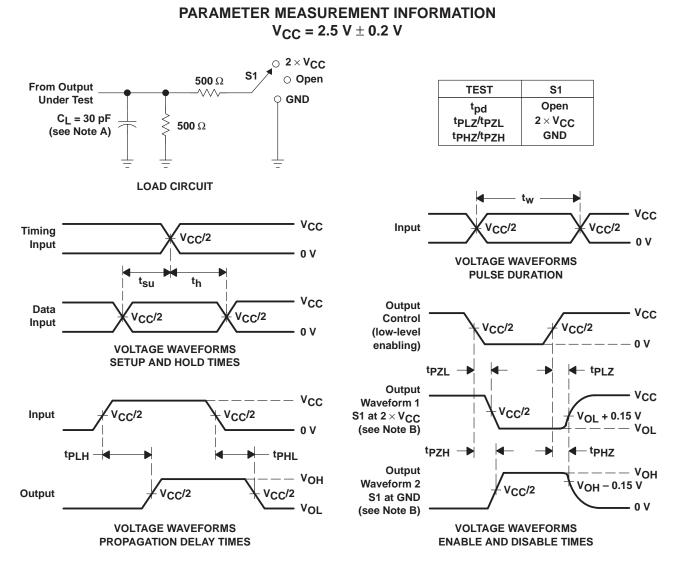


- NOTES: A.  $C_L$  includes probe and jig capacitance.
  - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
  - C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz, Z<sub>O</sub> = 50  $\Omega$ , t<sub>f</sub>  $\leq$  2 ns, t<sub>f</sub>  $\leq$  2 ns.
  - D. The outputs are measured one at a time with one transition per measurement.
  - E.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
  - F.  $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
  - G. tPLH and tPHL are the same as tpd.

### Figure 1. Load Circuit and Voltage Waveforms



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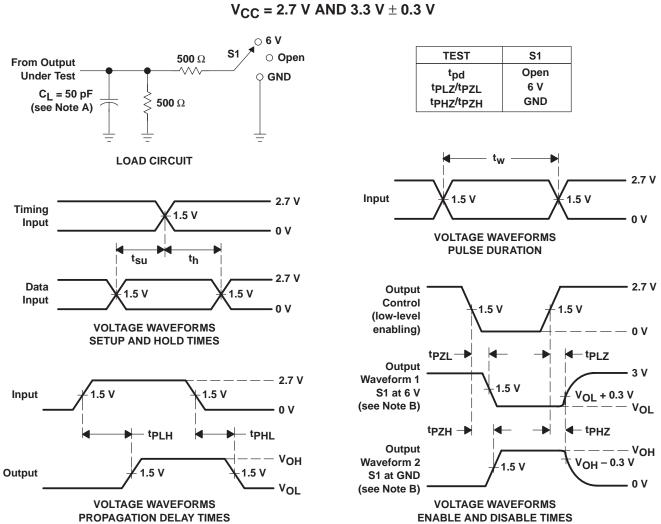


- NOTES: A. CL includes probe and jig capacitance.
  - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control. C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz, Z<sub>O</sub> = 50  $\Omega$ , t<sub>f</sub>  $\leq$  2 ns, t<sub>f</sub>  $\leq$  2 ns.
  - D. The outputs are measured one at a time with one transition per measurement.

  - E. tPLZ and tPHZ are the same as tdis.
  - F. tpzL and tpzH are the same as ten.
  - G. tPLH and tPHL are the same as tpd.

### Figure 2. Load Circuit and Voltage Waveforms





# PARAMETER MEASUREMENT INFORMATION

NOTES: A. C<sub>I</sub> includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control. C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz, Z<sub>Q</sub> = 50  $\Omega$ , t<sub>f</sub>  $\leq$  2.5 ns, t<sub>f</sub>  $\leq$  2.5 ns.
- D. The outputs are measured one at a time with one transition per measurement.
- E.  $t_{PI 7}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
- F. tpzL and tpzH are the same as ten.
- G. tPLH and tPHL are the same as tpd.

### Figure 3. Load Circuit and Voltage Waveforms



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